

05-24-2000

PATENT

Docket No.: NAU091



101366433

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RECORDING COVER SHEET

1. Assignor: Chin-Hui Lee , Ting-Chi Lin ,
Chih-Cheng Liu
2. Assignee: UNITED MICROELECTRONICS CORP.
No.3, Li-Hsin Road 2,
Science-Based Industrial Park,
Hsin-Chu, Taiwan, R.O.C.
3. Nature of Conveyance: Assignment of patent
4. Reference number: Application filed herewith.
5. Correspondence to: Winston Hsu
3F, No. 52, Lane 46, Min-Sheng Rd.,
Yung-Ho City, Taipei Hsien,
Taiwan, R.O.C.
6. Number of applications affected by this recording: 1
Total fee: (1 x \$ 40) = \$ 40.00 Payment by check enclosed
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7. Execution date of the document to be recorded: 10/28/1999
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Date: 05/11/2000

Winston Hsu

Winston Hsu
U.S. Patent Agent
Reg. No.: 41,526

MRO 5/17/00



~~04-21-2000~~



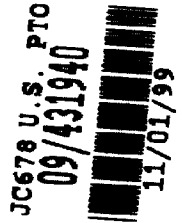
~~101307335~~

PATENT

Docket No.:NAU091

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Date: 10/28/1999

Winston Hsu

Winston Hsu
U.S. Patent Agent
Reg. No.:41,526

11/09/1999 MGORDON 00000028 09431940
02 FC:581

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Recording Cover Sheet Page 1 of 1

PATENT
REEL: 010799 FRAME: 0478

MRD 10.20.99

04-14-2000



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PATENT

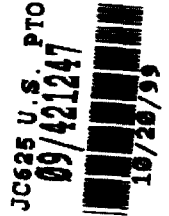
Docket No.: NAU085



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RECORDING COVER SHEET

1. Assignor: CHIEN-Li Kuo , Jung-Chao Chiou
2. Assignee: UNITED MICROELECTRONICS CORP.
No.3, Li-Hsin Road 2,
Science-Based Industrial Park,
Hsin-Chu, Taiwan, R.O.C.
3. Nature of Conveyance: Assignment of patent
4. Reference number: Application filed herewith.
5. Correspondence to: Winston Hsu **09.421247**
3F, No. 52, Lane 46, Min-Sheng Rd.,
Yung-Ho City, Taipei Hsien,
Taiwan, R.O.C.
6. Number of applications affected by this recording: 1
Total fee: (1 x \$ 40) = \$ 40.00 Payment by check enclosed
Authorization is hereby given to charge the over payment to deposit account #500801
7. Execution date of the document to be recorded: 10/12/1999
8. Total number of pages including cover sheet: 3
9. I declare under penalty of perjury that to the best of my knowledge and belief, the information contained on this cover sheet is true and correct, and that any copy submitted herewith is a true and correct copy of the original document.



Date:

10/13/1999

Winston Hsu

Winston Hsu
U.S. Patent Agent
Reg. No.: 41,526

10/27/1999 MUIILLARI 00000010 09421247

02 FC:581

(40.00 DP)

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNORS (Inventors):

Name: Chin-Hui Lee Nationality: R.O.C.

Address: No.17, Alley 20, Sec.2, Chih-Yu Rd., Chung-Cheng, Taipei City, Taiwan, R.O.C.

Name: Ting-Chi Lin Nationality: R.O.C.

Address: No.8-3, Chu-Chiao, Ta-Hu, Miao-Li Hsien, Taiwan, R.O.C.

Name: Chih-Cheng Liu Nationality: R.O.C.

Address: No.9-1, Alley 153, Han-Sheng W. Rd., Pan-Chiao City, Taiwan, R.O.C.

Name: _____ Nationality: _____

Address: _____

Hereby sells, assigns and transfers to **UNITED MICROELECTRONICS CORP.** (hereinafter "Assignee"), of (Assignee address) **No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.**, and the successors assigns and legal representatives of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled: **" Method of forming a level silicon oxide layer on two regions of different heights on a semiconductor wafer."**

Which is found in :

- (a) _____ U.S. patent application executed on even date herewith
- (b) _____ U.S. patent application executed on _____
- (c) _____ U.S. application serial no. _____
- (d) _____ patent no. _____ issued _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or ant continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this 10/26/99 (Date of signing).

(Type name of inventor)

Signature of INVENTOR

Chin-Hui Lee

Chin-Hui Lee

Ting-Chi Lin

Ting-Chi Lin

Chih-Cheng Liu

Chih-cheng Liu

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNORS (Inventors):

Name: Chien-Li Kuo Nationality: R.O.C.

Address: No.22, Alley 102, Lane 648, Ming-Hu Rd., Hsin-Chu City, Taiwan, R.O.C.

Name: Jung-Chao Chiou Nationality: R.O.C.

Address: No.312, Hsin-Esiang St., Hsin-Chu City, Taiwan, R.O.C.

Name: _____ Nationality: _____

Address: _____

Name: _____ Nationality: _____

Address: _____

Hereby sells, assigns and transfers to **UNITED MICROELECTRONICS CORP.** (hereinafter "Assignee"), of (Assignee address) **No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.**, and the successors assigns and legal representatives of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled: **"Method of forming a landing pad on a semiconductor wafer."**

Which is found in :

- (a) _____ U.S. patent application executed on even date herewith
- (b) _____ U.S. patent application executed on _____
- (c) _____ U.S. application serial no. _____
- (d) _____ patent no. _____ issued _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or ant continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof

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IN WITNESS WHEREOF, We have hereunto set hand and seal this _____ (Date of signing).

(Type name of inventor)

Signature of INVENTOR

Chien-Li Kuo

Chien-Li Kuo 27. Sep. 1999

Jung-Chao Chiou

J. C. Chiou 27 Sep 1
